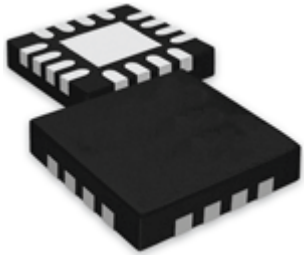
Features

- Ultra-low supply current (all at 3V):
  - 14 nA with RC oscillator
  - 22 nA with RC oscillator and Autocalibration
  - 55 nA with crystal oscillator
- Baseline timekeeping features:
  - 32.768 kHz crystal oscillator with integrated load capacitor/resistor
  - Counters for hundredths, seconds, minutes, hours, date, month, year, century, and week-day
  - Alarm capability on all counters
  - Programmable output clock generation (32.768 kHz to 1 year)
  - Countdown timer with repeat function
  - Automatic leap year calculation
- Advanced timekeeping features:
  - Integrated power optimized RC oscillator
  - Advanced crystal calibration to ± 2 ppm
  - Advanced RC calibration to ± 16 ppm
  - Automatic calibration of RC oscillator to crystal oscillator
  - Watchdog timer with hardware reset
  - Up to 256 bytes of general purpose RAM
- Power management features:
  - Automatic switchover to VBAT
  - External interrupt monitor
  - Programmable low battery detection threshold
  - Programmable analog voltage comparator
- I^2C (up to 400 kHz) and 3-wire or 4-wire SPI (up to 2 MHz) serial interfaces available
- Operating voltage 1.5-3.6 V
- Clock and RAM retention voltage 1.5-3.6 V
- Operating temperature –40 to 85 °C
- All inputs include Schmitt Triggers
- 3x3 mm QFN-16 package



Applications

- Smart cards
- Wireless sensors and tags
- Medical electronics
- Utility meters
- Data loggers
- Appliances
- Handsets
- Consumer electronics
- Communications equipment

Description

The ABRACON AB08XX Real Time Clock family provides a groundbreaking combination of ultra-low power coupled with a highly sophisticated feature set. With power requirements significantly lower than any other industry RTC (as low as 14 nA), these are the first semiconductors based on innovative SPOT™ (Subthreshold Power Optimized Technology) CMOS platform. The AB08XX includes on-chip oscillators to provide minimum power consumption, full RTC functions including battery backup and programmable counters and alarms for timer and watchdog functions, and either an I^2C or SPI serial interface for communication with a host controller.

Disclaimer: AB08XX series of devices are based on innovative SPOT technology, proprietary to Ambiq Micro.

1. Family Summary

The AB08XX family consists of several members (see Table 1). All devices are supplied in a standard 3x3 mm QFN-16 package. Members of the software and pin compatible AB08XX RTC family are also listed.

Table 1: Family Summary

Part #	Baseline Timekeeping		Advanced Timekeeping				Power Management				Interface
	XT Osc	Number of GP Outputs	RC Osc	Calib/ Auto-calib	Watch-dog	RAM (B)	VBAT Switch	Reset Mgmt	Ext Int	Power Switch and Sleep FSM	
AB0801	■	2	■	■		0					I^2C
AB0803	■	2	■	■		64	■				I^2C
AB0804	■	4	■	■	■	256			■		I^2C
AB0805	■	4	■	■	■	256	■		■		I^2C
AB0811	■	2	■	■		0					SPI
AB0813	■	2	■	■		64	■				SPI
AB0814	■	3	■	■	■	256			■		SPI
AB0815	■	3	■	■	■	256	■		■		SPI
Software and Pin Compatible AB18XX Family Components											
AB1801	■	2	■	■		0				■	I^2C
AB1803	■	2	■	■		64	■			■	I^2C
AB1804	■	4	■	■	■	256		■	■	■	I^2C
AB1805	■	4	■	■	■	256	■	■	■	■	I^2C
AB1811	■	2	■	■		0				■	SPI
AB1813	■	2	■	■		64	■			■	SPI
AB1814	■	3	■	■	■	256		■	■	■	SPI
AB1815	■	3	■	■	■	256	■	■	■	■	SPI

2. Functional Description

Figure 1 illustrates the AB08XX functional design.

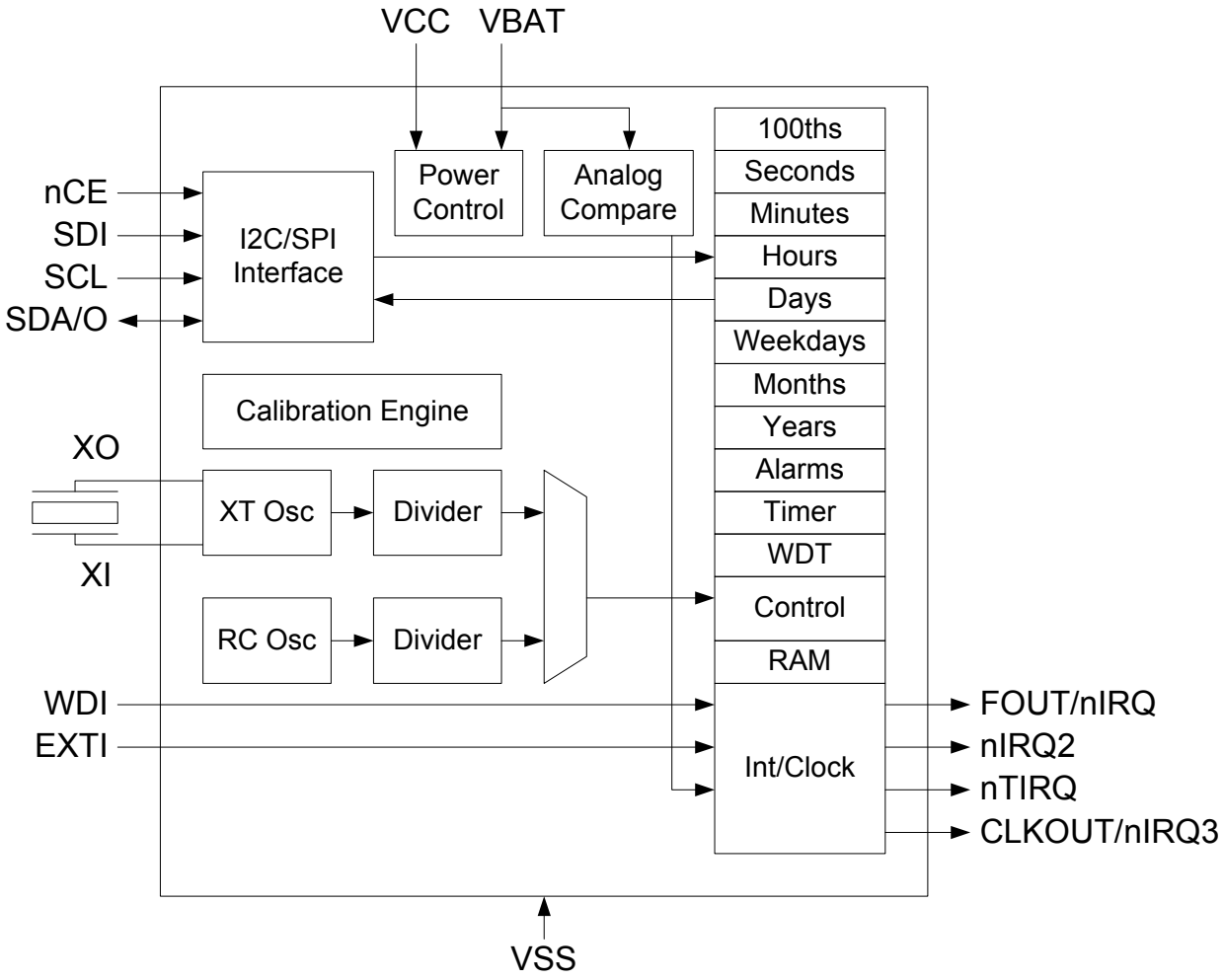


Figure 1. Detailed Block Diagram

The AB08XX serves as a full function RTC for host processors such as microcontrollers. The AB08XX includes 3 distinct feature groups: 1) baseline timekeeping features, 2) advanced timekeeping features, and 3) basic power management features. Functions from each feature group may be controlled via I/O offset mapped registers. These registers are accessed using either an I^2C serial interface (e.g., in the AB0805) or a SPI serial interface (e.g., in the AB0815). Each feature group is described briefly below and in greater detail in subsequent sections.

The baseline timekeeping feature group supports the standard 32.786 kHz crystal (XT) oscillation mode for maximum frequency accuracy with an ultra-low current draw of 55 nA. The baseline timekeeping feature group also includes a standard set of counters monitoring hundredths of a second up through centuries. A complement of countdown timers and alarms may additionally be set to initiate interrupts or resets on several of the outputs.

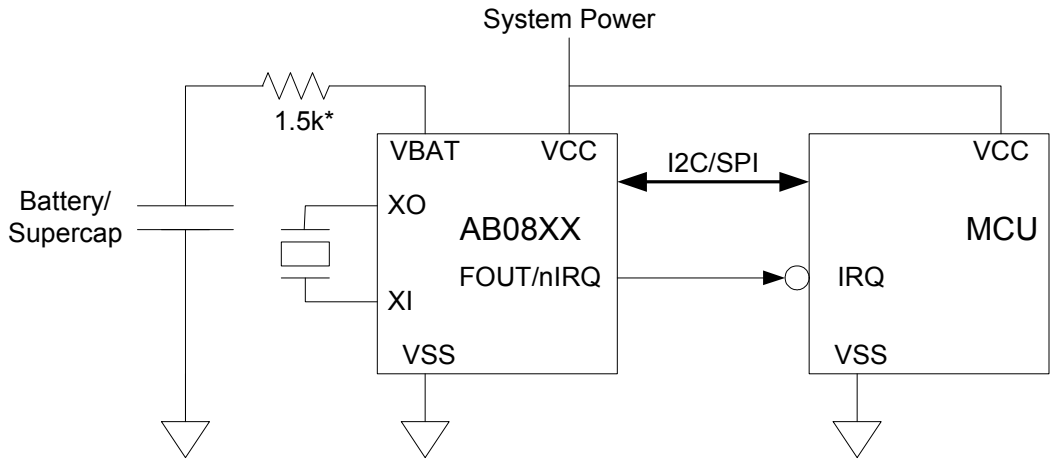
The advanced timekeeping feature group supports two additional oscillation modes: 1) RC oscillator mode, and 2) Autocalibration mode. At only 14 nA, the temperature-compensated RC oscillator mode provides an even lower current draw than the XT oscillator for applications with reduced frequency accuracy requirements. A proprietary calibration algorithm allows the AB08XX to digitally tune the RC oscillator frequency and the XT oscillator frequency with accuracy as low as 2 ppm at a given temperature. In Autocalibration mode, the RC oscillator is used as the primary oscillation source and is periodically calibrated against the XT oscillator. Autocalibration may be done automatically every 8.5 minutes or 17 minutes and may also be initiated via software. This mode enables average current draw of only 22 nA with frequency accuracy similar to the XT oscillator. The advanced timekeeping feature group also includes a rich set of input and output configuration options that enables the monitoring of external interrupts (e.g., pushbutton signals), the generation of clock outputs, and watchdog timer functionality.

Power management features built into the AB08XX enable it to operate as a backup device in both line-powered and battery-powered systems. An integrated power control module automatically detects when main power (VCC) falls below a threshold and switches to backup power (VBAT). Up to 256B of ultra-low leakage RAM enable the storage of key parameters when operating on backup power. The AB08XX also includes digitally-tunable voltage detection on the backup power supply. VBAT power switching is included in the AB0803, AB0813, AB0813 and AB0815 parts only.

3. AB08XX Example Applications

3.1 Battery Backed Up RTC

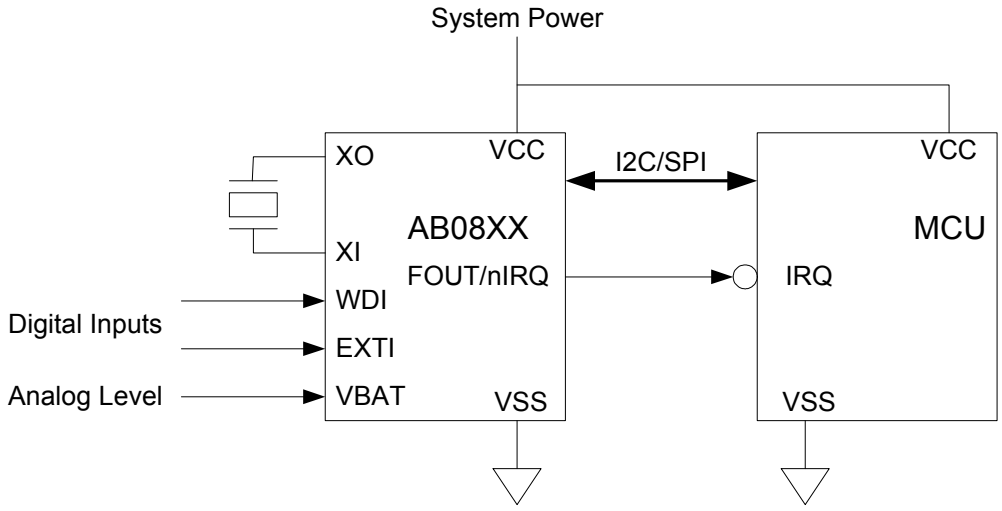
The most common AB08XX application is a battery backed up RTC, which maintains time and may hold data in RAM. The AB08XX is normally powered from a system power supply, which may be a larger battery. The AB08XX is continuously charging a supercapacitor or rechargeable battery via the internal trickle charger. When the main power supply goes away, the AB08XX automatically switches to the VBAT supply and maintains time and RAM data at very low battery supply currents.



* Total battery series impedance = 1.5k ohms, which may require an external resistor

3.2 RTC with Interrupt Aggregation

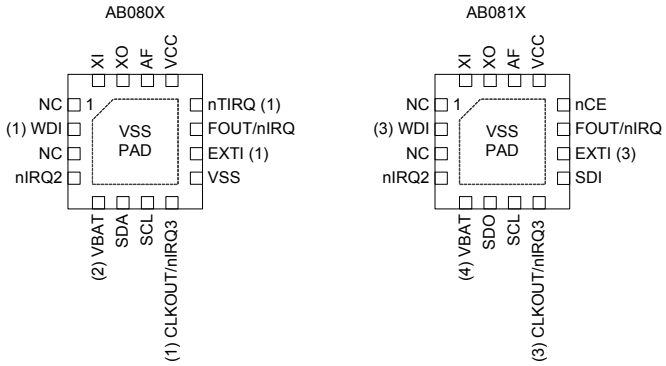
The flexible inputs of the AB08XX can be used to aggregate a variety of interrupt sources, including external digital inputs, analog levels, timers and alarms into a single interrupt source to an MCU.



4. Package Pins

4.1 Pin Configuration and Connections

Figure 2 and Table 2 show the QFN-16 pin configurations for the AB08XX parts. Pins labeled NC must be left unconnected. The thermal pad, pin 17, on the QFN-16 packages must be connected to VSS.



(1) Available in AB0804 and AB0805 only, else NC
(2) Available in AB0803 and AB0805 only, else VSS
(3) Available in AB0814 and AB0815 only, else NC
(4) Available in AB0813 and AB0815 only, else VSS

Figure 2. Pin Configuration Diagram

Table 2: Pin Connections

Pin Name	Pin Type	Function	Pin Number in AB08XX							
			01	03	04	05	11	13	14	15
VSS	Power	Ground	5,9,17	9,17	5,9,17	9,17	5,17	17	5,17	17
VCC	Power	System power supply	13	13	13	13	13	13	13	13
XI	XT	Crystal input	16	16	16	16	16	16	16	16
XO	XT	Crystal output	15	15	15	15	15	15	15	15
AF	Output	Autocalibration filter	14	14	14	14	14	14	14	14
VBAT	Power	Battery power supply		5		5		5		5
SCL	Input	I^2C or SPI interface clock	7	7	7	7	7	7	7	7
SDO	Output	SPI data output					6	6	6	6
SDI	Input	SPI data input					9	9	9	9
nCE	Input	SPI chip select					12	12	12	12
SDA	Input	I^2C data input/output	6	6	6	6				
EXTI	Input	External interrupt input			10	10			10	10
WDI	Input	Watchdog reset input			2	2			2	2
FOUT/nIRQ	Output	Int 1/function output	11	11	11	11	11	11	11	11
nIRQ2	Output	Int 2 output	4	4	4	4	4	4	4	4
CLKOUT/nIRQ3	Output	Int 3/clock output			8	8			8	8
nTIRQ	Output	Timer interrupt output			12	12				

4.2 Pin Descriptions

Table 3 provides a description of the pin connections.

Table 3: Pin Descriptions

Pin Name	Description
VSS	Ground connection. In the QFN-16 packages the ground slug on the bottom of the package must be connected to VSS.
VCC	Primary power connection. If a single power supply is used, it must be connected to VCC.
VBAT	Battery backup power connection. If a backup battery is not present, VBAT is normally left floating or grounded, but it may also be used to provide the analog input to the internal comparator (see Analog-Comparator).
XI	Crystal oscillator input connection.
XO	Crystal oscillator output connection.
AF	Autocalibration filter connection. A 47pF ceramic capacitor should be placed between this pin and VSS for improved Autocalibration mode timing accuracy.
SCL	I/O interface clock connection. It provides the SCL input in both I^2C and SPI interface parts.
SDA (only available in I^2C environments)	I/O interface I^2C data connection.
SDO (only available in SPI environments)	I/O interface SPI data output connection.
SDI	I/O interface SPI data input connection.
nCE (only available in SPI environments)	I/O interface SPI chip select input connection. It is an active low signal. A pull-up resistor is recommended to be connected to this pin to ensure it is not floating. A pull-up resistor also prevents inadvertent writes to the RTC during power transitions.
EXTI	External interrupt input connection. It may be used to generate an External 1 interrupt with polarity selected by the EX1P bit if enabled by the EX1E bit. The value of the EXTI pin may be read in the EXIN register bit. This pin does not have an internal pull resistor. It must not be left floating or the RTC may consume higher current.
WDI	Watchdog Timer reset input connection. It may also be used to generate an External 2 interrupt with polarity selected by the EX2P bit if enabled by the EX2E bit. The value of the WDI pin may be read in the WDIN register bit. This pin does not have an internal pull resistor. It must not be left floating or the RTC may consume higher current.
FOUT/nIRQ	Primary interrupt output connection. FOUT/nIRQ may be configured to generate several signals as a function of the OUT1S field(see 0x11 - Control2). FOUT/nIRQ is also asserted low on a power up until the AB08XX has exited the reset state and is accessible via the I/O interface. 1. FOUT/nIRQ can drive the value of the OUT bit. 2. FOUT/nIRQ can drive the inverse of the combined interrupt signal IRQ (see Interrupts). 3. FOUT/nIRQ can drive the square wave output (see 0x13 - SQW) if enabled by SQWE. 4. FOUT/nIRQ can drive the inverse of the alarm interrupt signal AIRQ (see Interrupts).

Table 3: Pin Descriptions

Pin Name	Description
nIRQ2	1. Secondary interrupt output connection. It is an open drain output. nIRQ2 may be configured to generate several signals as a function of the OUT2S field (see 0x11 - Control2).nIRQ2 can drive the value of the OUTB bit. 2. nIRQ2 can drive the square wave output (see 0x13 - SQW) if enabled by SQWE. 3. nIRQ2 can drive the inverse of the combined interrupt signal IRQ(see Interrupts). 4. nIRQ2 can drive the inverse of the alarm interrupt signal AIRQ(see Interrupts). 5. nIRQ2 can drive either sense of the timer interrupt signal TIRQ.
nTIRQ (only available in I^2C environments)	Timer interrupt output connection. It is an open drain output. nTIRQ always drives the active low nTIRQ signal.
CLKOUT/nIRQ3	Square Wave output connection. It is a push-pull output, and may be configured to generate one of two signals. 1. CLKOUT/nIRQ3 can drive the value of the OUT bit. 2. CLKOUT/nIRQ3 can drive the square wave output (see 0x13 - SQW) if enabled by SQWE.

5. Electrical Specifications

5.1 Absolute Maximum Ratings

Table 4 lists the absolute maximum ratings.

Table 4: Absolute Maximum Ratings

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{CC}	System Power Voltage		-0.3		3.8	V
V_{BAT}	Battery Voltage		-0.3		3.8	V
V_I	Input voltage	VCC Power state	-0.3		V_{CC}+ 0.3	V
V_I	Input voltage	VBAT Power state	-0.3		V_{BAT}+ 0.3	V
V_O	Output voltage	VCC Power state	-0.3		V_{CC}+ 0.3	V
V_O	Output voltage	VBAT Power state	-0.3		V_{BAT}+ 0.3	V
I_I	Input current		-10		10	mA
I_O	Output current		-20		20	mA
V_{ESD}	ESD Voltage	CDM			±500	V
		HBM			±4000	V
I_{LU}	Latch-up Current				100	mA
T_{STG}	Storage Temperature		-55		125	°C
T_{OP}	Operating Temperature		-40		85	°C
T_{SLD}	Lead temperature	Hand soldering for 10 seconds			300	°C
T_{REF}	Reflow soldering temperature	Reflow profile per JEDEC J-STD-020D			260	°C

5.2 Power Supply Parameters

Figure 3 and Table 5 describe the power supply and switchover parameters. See Power Control and Switching for a detailed description of the operations.

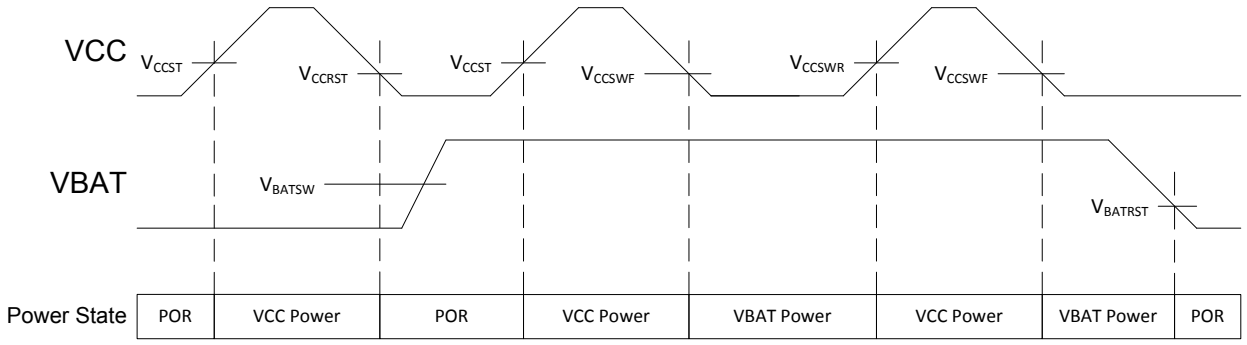


Figure 3. Power Supply Switchover

For Table 5, T_A = -40 °C to 85 °C, TYP values at 25 °C.

Table 5: Power Supply and Switchover Parameters

SYMBOL	PARAMETER	PWR	TYPE	POWER STATE	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{CC}	System Power Voltage	VCC	Static	VCC Power	Clocks operating and RAM and registers retained	1.5		3.6	V
V_{CCIO}	VCC I/O Interface Voltage	VCC	Static	VCC Power	I^2C or SPI operation	1.5		3.6	V
V_{CCST}	VCC Start-up Voltage(1)	VCC	Rising	POR -> V_{CC} Power		1.6			V
V_{CCRST}	VCC Reset Voltage	VCC	Falling	VCC Power -> POR	$V_{BAT} < V_{BAT,MIN}$ or no V_{BAT}		1.3	1.5	V
V_{CCSWR}	VCC Rising Switch-over Threshold Voltage	VCC	Rising	VBAT Power -> VCC Power	$V_{BAT} \geq V_{BATRST}$		1.6	1.7	V
V_{CCSWF}	VCC Falling Switch-over Threshold Voltage	VCC	Falling	VCC Power -> VBAT Power	$V_{BAT} \geq V_{BATSW,MIN}$	1.2	1.5		V
V_{CCSWH}	VCC Switchover Threshold Hysteresis(2)	VCC	Hyst.	VCC Power <-> VBAT Power			70		mV
V_{CCFS}	VCC Falling Slew Rate to switch to VBAT state(4)	VCC	Falling	VCC Power -> VBAT Power	$V_{CC} < V_{CCSW,MAX}$	0.7	1.4		V/ms
V_{BAT}	Battery Voltage	VBAT	Static	VBAT Power	Clocks operating and RAM and registers retained	1.4		3.6	V
V_{BATSW}	Battery Switchover Voltage Range(5)	VBAT	Static	VCC Power -> VBAT Power		1.6		3.6	V
V_{BATRST}	Falling Battery POR Voltage(7)	VBAT	Falling	VBAT Power -> POR	$V_{CC} < V_{CCSWF}$		1.1	1.4	V
V_{BMRG}	V_{BAT} Margin above V_{CC}(3)	VBAT	Static	V_{BAT} Power		200			mV
V_{BATESR}	V_{BAT} supply series resistance(6)	VBAT	Static	V_{BAT} Power		1.0	1.5		kΩ

(1) V_{CC} must be above V_{CCST} to exit the POR state, independent of the V_{BAT} voltage.

(2) Difference between V_{CCSWR} and V_{CCSWF}.

(3) V_{BAT} must be higher than V_{CC} by at least this voltage to ensure the AB08XX remains in the VBAT Power state.

(4) Maximum VCC falling slew rate to guarantee correct switchover to VBAT Power state. There is no V_{CC} falling slew rate requirement if switching to the VBAT power source is not required.

(5) V_{BAT} voltage to guarantee correct transition to VBAT Power state when V_{CC} falls.

(6) Total series resistance of the power source attached to the VBAT pin. The optimal value is 1.5kΩ, which may require an external resistor. VBAT power source ESR + external resistor value = 1.5kΩ.

(7) V_{BATRST} is also the static voltage required on V_{BAT} for register data retention.

5.3 Operating Parameters

Table 6 lists the operating parameters.

For Table 6, T_A = -40 °C to 85 °C, TYP values at 25 °C.

Table 6: Operating Parameters

SYMBOL	PARAMETER	TEST CONDITIONS	V_{CC}	MIN	TYP	MAX	UNIT
V_{T+}	Positive-going Input Threshold Voltage		3.0V		1.5	2.0	V
			1.8V		1.1	1.25	
V_{T-}	Negative-going Input Threshold Voltage		3.0V	0.8	0.9		V
			1.8V	0.5	0.6		
I_{ILEAK}	Input leakage current		3.0V		0.02	80	nA
C_I	Input capacitance				3		pF
V_{OH}	High level output voltage on push-pull outputs		1.7V – 3.6V	0.8•V_{CC}			V
V_{OL}	Low level output voltage		1.7V – 3.6V			0.2•V_{CC}	V
I_{OH}	High level output current on push-pull outputs	V_{OH} = 0.8•V_{CC}	1.7V	-2	-3.8		mA
			1.8V	-3	-4.3		
			3.0V	-7	-11		
			3.6V	-8.8	-15		
I_{OL}	Low level output current	V_{OL} = 0.2•V_{CC}	1.7V	3.3	5.9		mA
			1.8V	6.1	6.9		
			3.0V	17	19		
			3.6V	18	20		
I_{OLEAK}	Output leakage current				0.02	80	nA

5.4 Oscillator Parameters

Table 7 lists the oscillator parameters.

For Table 7, T_A = -40 °C to 85 °C unless otherwise indicated.
V_{CC} = 1.7 to 3.6V, TYP values at 25 °C and 3.0V.

Table 7: Oscillator Parameters

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
F_{XT}	XI and XO pin Crystal Frequency			32.768		kHz
F_{OF}	XT Oscillator failure detection frequency			8		kHz
C_{INX}	Internal XI and XO pin capacitance			1		pF
C_{EX}	External XI and XO pin PCB capacitance			1		pF
OA_{XT}	XT Oscillation Allowance	At 25°C using a 32.768 kHz crystal	270	320		kΩ
F_{RCC}	Calibrated RC Oscillator Frequency(1)	Factory Calibrated at 25°C, VCC = 2.8V		128		Hz
F_{RCU}	Uncalibrated RC Oscillator Frequency	Calibration Disabled (OFFSETR = 0)	89	122	220	Hz
J_{RCCC}	RC Oscillator cycle-to-cycle jitter	Calibration Disabled (OFFSETR = 0) – 128 Hz		2000		ppm
		Calibration Disabled (OFFSETR = 0) – 1 Hz		500		
A_{XT}	XT mode digital calibration accuracy(1)	Calibrated at an initial temperature and voltage	-2		2	ppm
A_{AC}	Autocalibration mode timing accuracy, 512 second period, T_A = -10°C to 60°C(1)	24 hour run time		35		ppm
		1 week run time		20		
		1 month run time		10		
		1 year run time		3		
T_{AC}	Autocalibration mode operating temperature(2)		-10		60	°C

(1) Timing accuracy is specified at 25°C after digital calibration of the internal RC oscillator and 32.768 kHz crystal. A typical 32.768 kHz tuning fork crystal has a negative temperature coefficient with a parabolic frequency deviation, which can result in a change of up to 150 ppm across the entire operating temperature range of -40°C to 85°C in XT mode. Autocalibration mode timing accuracy is specified relative to XT mode timing accuracy from -10°C to 60°C.

(2) Outside of this temperature range, the RC oscillator frequency change due to temperature may be outside of the allowable RC digital calibration range (+/-12%) for autocalibration mode. When this happens, an autocalibration failure will occur and the ACF interrupt flag is set. The AB08XX should be switched to use the XT oscillator as its clock source when this occurs. Please see the Autocalibration Fail section for more details.

Figure 4 shows the typical calibrated RC oscillator frequency variation vs. temperature. RC oscillator calibrated at 2.8V, 25°C.

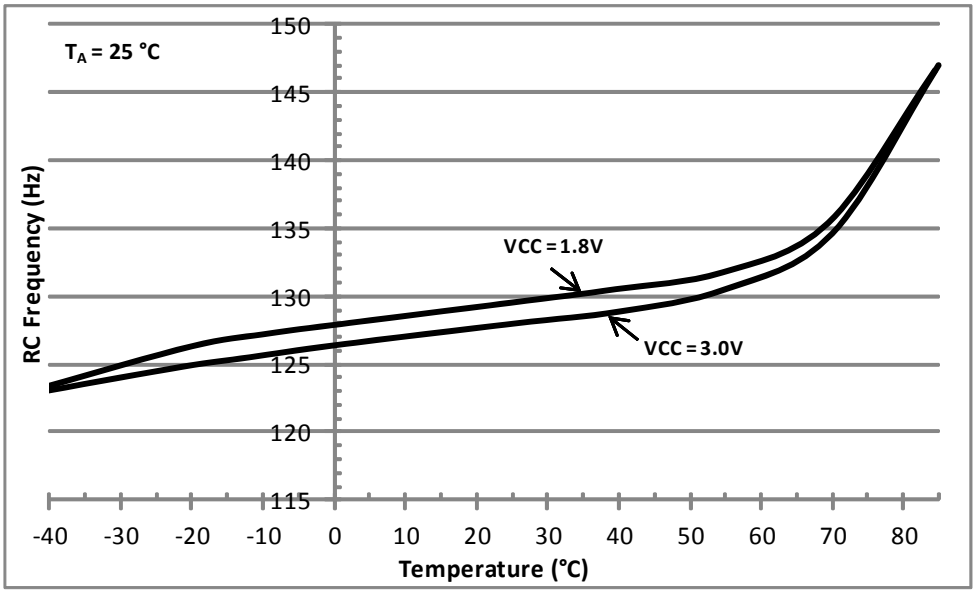


Figure 4. Calibrated RC Oscillator Typical Frequency Variation vs. Temperature

Figure 5 shows the typical uncalibrated RC oscillator frequency variation vs. temperature.

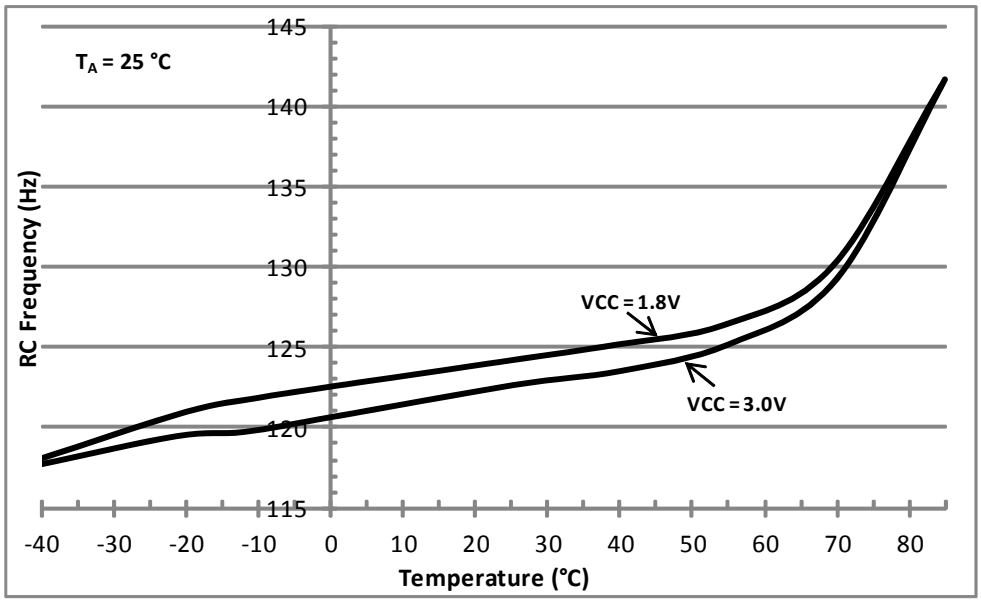


Figure 5. Uncalibrated RC Oscillator Typical Frequency Variation vs. Temperature

5.5 V_{CC} Supply Current

Table 8 lists the current supplied into the VCC power input under various conditions.

For Table 8, T_A = -40 °C to 85 °C, VBAT = 0 V to 3.6 V
TYP values at 25 °C, MAX values at 85 °C, VCC Power state

Table 8: V_{CC} Supply Current

SYMBOL	PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	UNIT
$I_{VCC:I2C}$	V_{CC} supply current during I^2C burst read/write	400kHz bus speed, 2.2k pull-up resistors on SCL/SDA(1)	3.0V		6	10	µA
			1.8V		1.5	3	
$I_{VCC:SPIW}$	V_{CC} supply current during SPI burst write	2 MHz bus speed (2)	3.0V		8	12	µA
			1.8V		4	6	
$I_{VCC:SPIR}$	V_{CC} supply current during SPI burst read	2 MHz bus speed (2)	3.0V		23	37	µA
			1.8V		13	21	
$I_{VCC:XT}$	V_{CC} supply current in XT oscillator mode	Time keeping mode with XT oscillator running(3)	3.0V		55	330	nA
			1.8V		51	290	
$I_{VCC:RC}$	V_{CC} supply current in RC oscillator mode	Time keeping mode with only the RC oscillator running (XT oscillator is off)(3)	3.0V		14	220	nA
			1.8V		11	170	
$I_{VCC:ACAL}$	Average V_{CC} supply current in Autocalibrated RC oscillator mode	Time keeping mode with only RC oscillator running and Autocalibration enabled. ACP = 512 seconds(3)	3.0V		22	235	nA
			1.8V		18	190	
$I_{VCC:CK32}$	Additional V_{CC} supply current with CLKOUT at 32.786 kHz	Time keeping mode with XT oscillator running, 32.786 kHz square wave on CLKOUT(4)	3.0V		3.6	8	µA
			1.8V		2.2	5	
$I_{VCC:CK128}$	Additional V_{CC} supply current with CLKOUT at 128 Hz	All time keeping modes, 128 Hz square wave on CLKOUT(4)	3.0V		7	35	nA
			1.8V		2.5	20	

(1) Excluding external peripherals and pull-up resistor current. All other inputs (besides SDA and SCL) are at 0V or V_{CC}. AB080X only. Test conditions: Continuous burst read/write, 0x55 data pattern, 25 µs between each data byte, 20 pF load on each bus pin.

(2) Excluding external peripheral current. All other inputs (besides SDI, nCE and SCL) are at 0V or V_{CC}. AB081X only. Test conditions: Continuous burst write, 0x55 data pattern, 25 µs between each data byte, 20 pF load on each bus pin.

(3) All inputs and outputs are at 0 V or V_{CC}.

(4) All inputs and outputs except CLKOUT are at 0 V or V_{CC}. 15 pF capacitive load on CLKOUT.

Figure 6 shows the typical VCC power state operating current vs. temperature in XT mode.

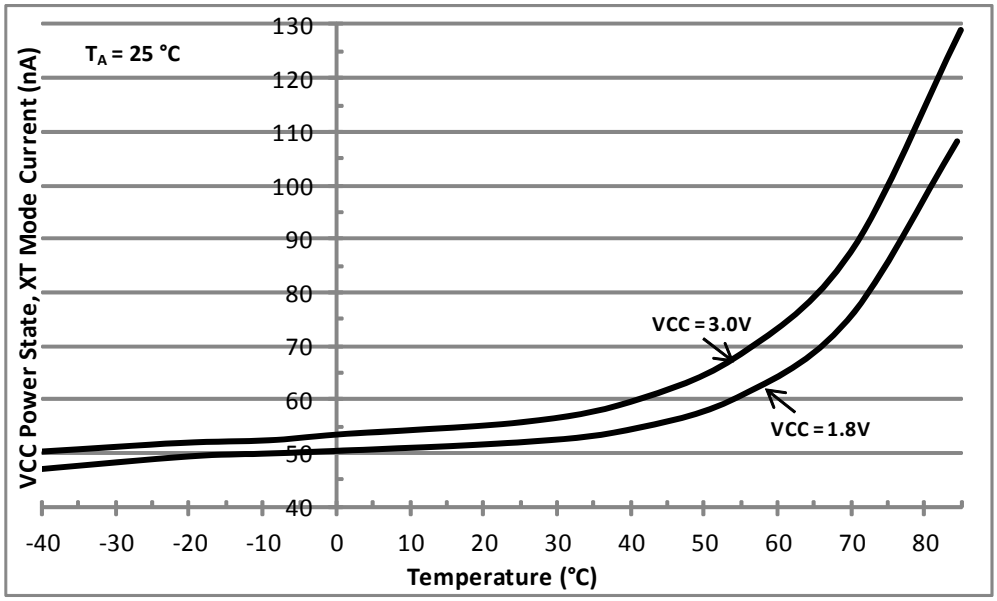


Figure 6. Typical VCC Current vs. Temperature in XT Mode

Figure 7 shows the typical VCC power state operating current vs. temperature in RC mode.

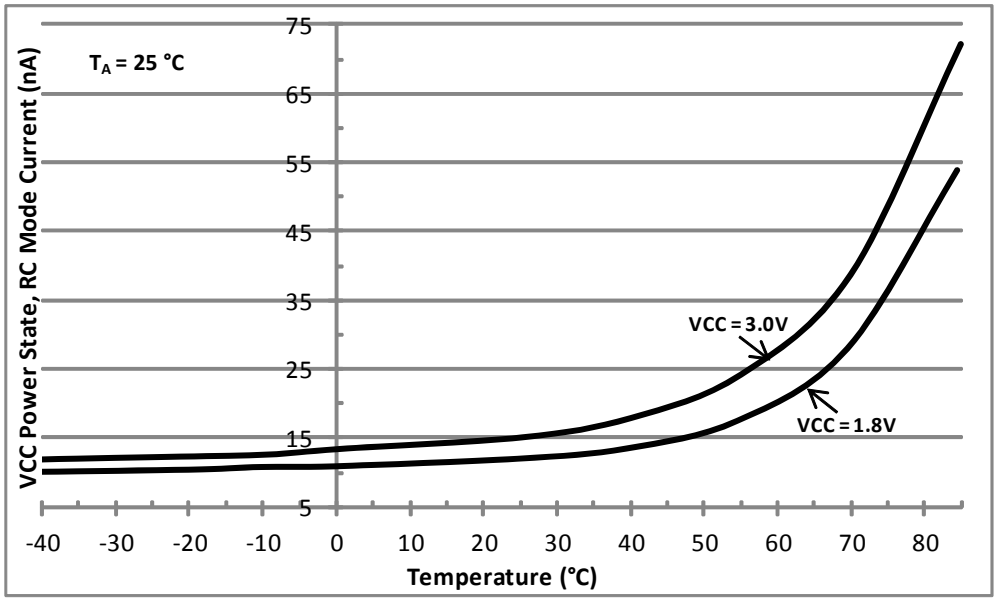


Figure 7. Typical VCC Current vs. Temperature in RC Mode

Figure 8 shows the typical VCC power state operating current vs. temperature in RC Autocalibration mode.

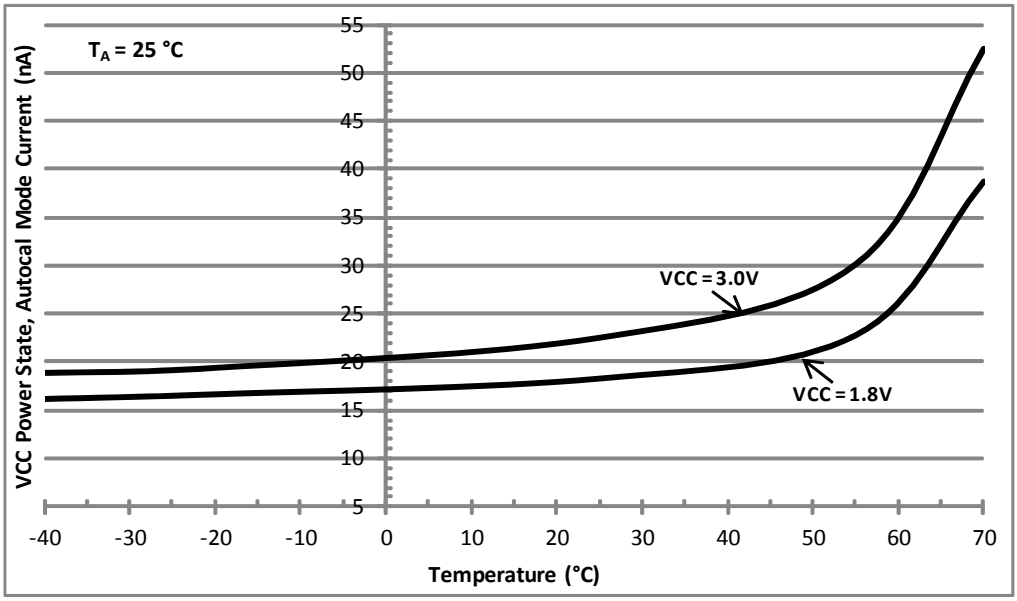


Figure 8. Typical VCC Current vs. Temperature in RC Autocalibration Mode

Figure 9 shows the typical VCC power state operating current vs. voltage for XT Oscillator and RC Oscillator modes and the average current in RC Autocalibrated mode.

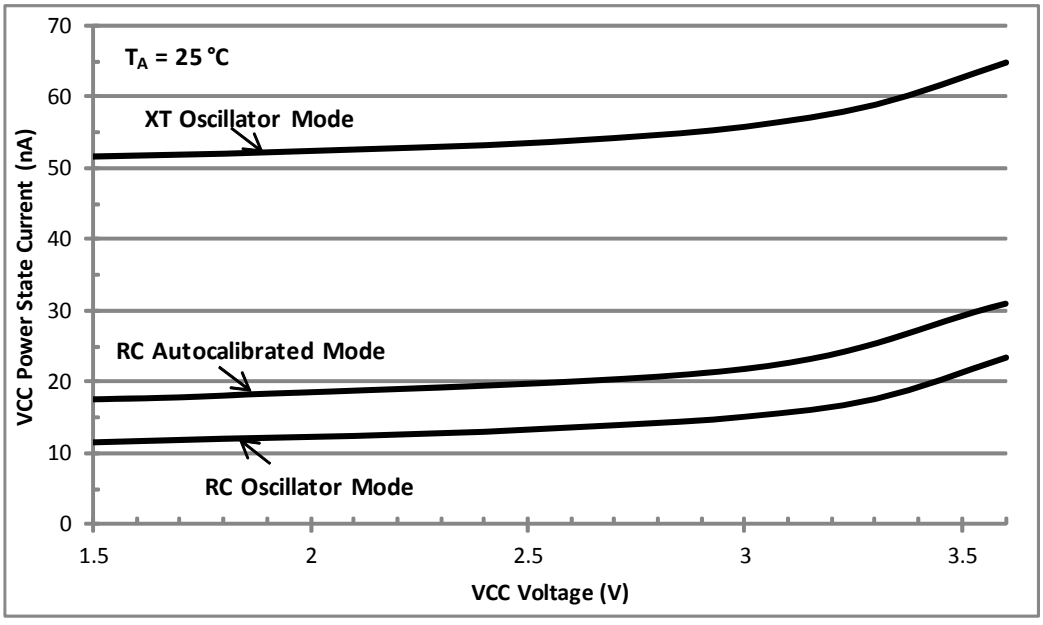


Figure 9. Typical VCC Current vs. Voltage, Different Modes of Operation

Figure 10 shows the typical VCC power state operating current during continuous I^2C and SPI burst read and write activity. Test conditions: T_A = 25 °C, 0x55 data pattern, 25 µs between each data byte, 20 pF load on each bus pin, pull-up resistor current not included.

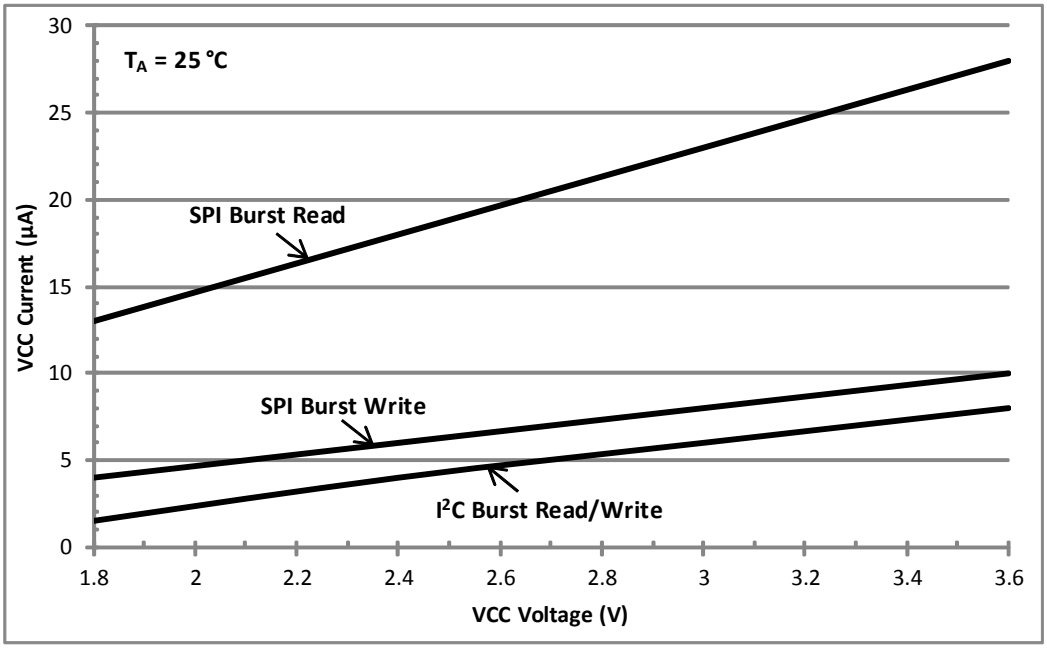


Figure 10. Typical VCC Current vs. Voltage, I^2C and SPI Burst Read/Write

Figure 11 shows the typical VCC power state operating current with a 32.768 kHz clock output on the CLKOUT pin. Test conditions: T_A = 25 °C, All inputs and outputs except CLKOUT are at 0 V or VCC. 15 pF capacitive load on the CLKOUT pin.

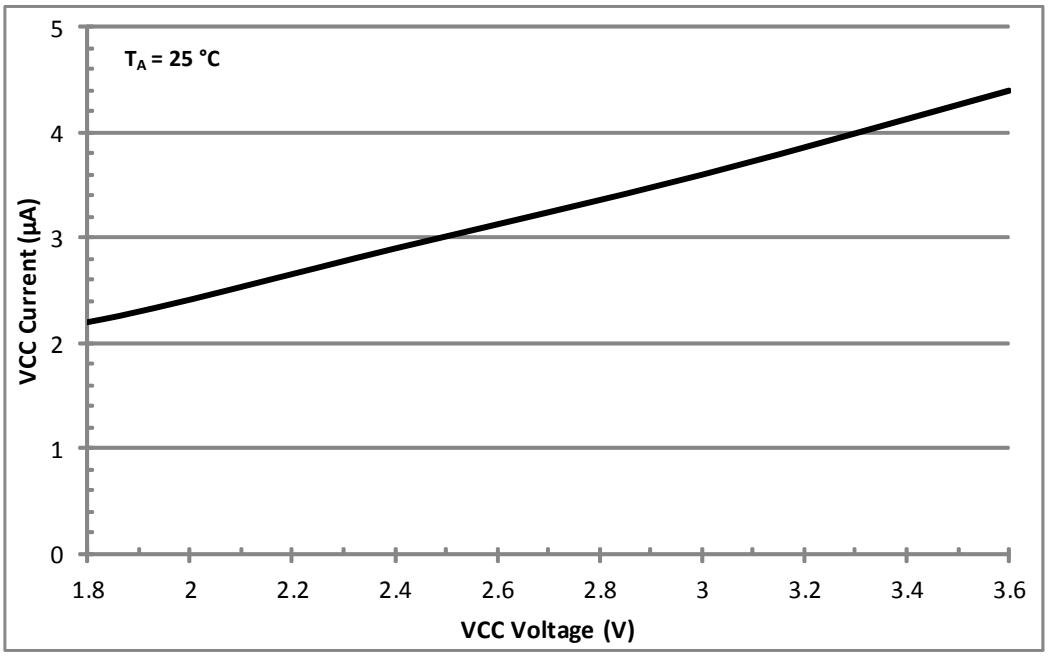


Figure 11. Typical VCC Current vs. Voltage, 32.768 kHz Clock Output

5.6 VBAT Supply Current

Table 9 lists the current supplied into the VBAT power input under various conditions.

For Table 9, T_A = -40 °C to 85 °C, TYP values at 25 °C, MAX values at 85 °C, V_{BAT} Power state.

Table 9: V_{BAT} Supply Current

SYMBOL	PARAMETER	TEST CONDITIONS	V_{CC}	V_{BAT}	MIN	TYP	MAX	UNIT
$I_{VBAT:XT}$	VBAT supply current in XT oscillator mode	Time keeping mode with XT oscillator running(1)	< V_{CCSWF}	3.0V		56	330	nA
				1.8V		52	290	
$I_{VBAT:RC}$	VBAT supply current in RC oscillator mode	Time keeping mode with only the RC oscillator running (XT oscillator is off)(1)	< V_{CCSWF}	3.0V		16	220	nA
				1.8V		12	170	
$I_{VBAT:ACAL}$	Average VBAT supply current in Autocalibrated RC oscillator mode	Time keeping mode with the RC oscillator running. Autocalibration enabled. ACP = 512 seconds(1)	< V_{CCSWF}	3.0V		24	235	nA
				1.8V		20	190	
$I_{VBAT:VCC}$	VBAT supply current in VCC powered mode	V_{CC} powered mode(1)	1.7 - 3.6 V	3.0V	-5	0.6	20	nA
				1.8V	-10	0.5	16	
(1) Test conditions: All inputs and outputs are at 0 V or V_{CC}.								

Figure 12 shows the typical VBAT power state operating current vs. temperature in XT mode.

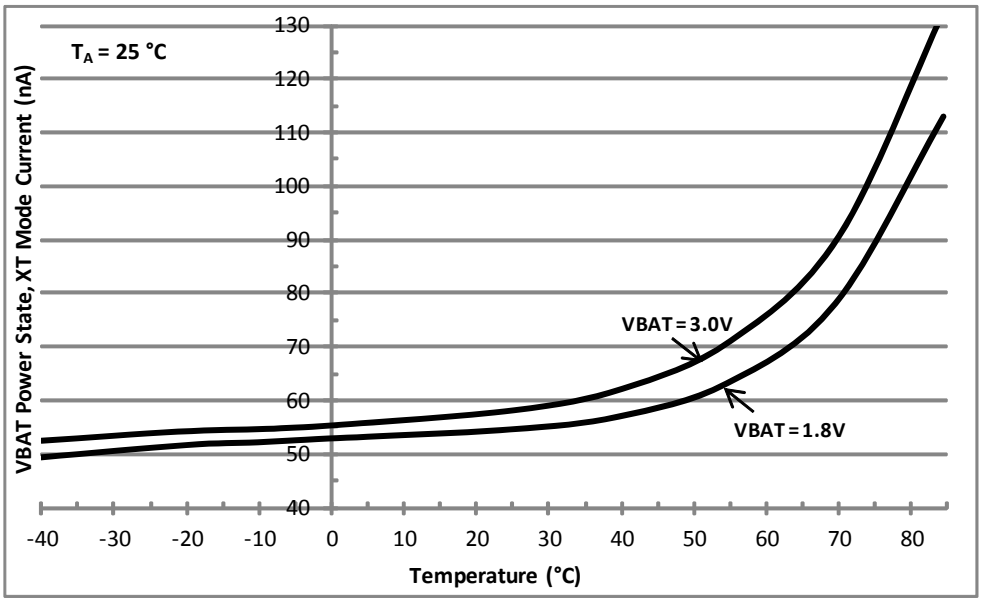


Figure 12. Typical VBAT Current vs. Temperature in XT Mode

Figure 13 shows the typical VBAT power state operating current vs. temperature in RC mode.

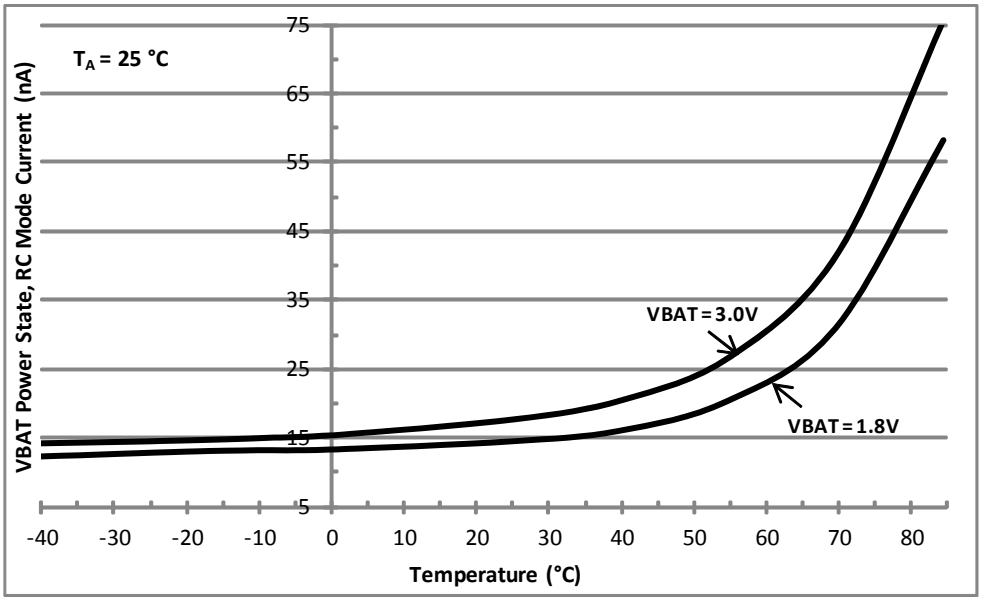


Figure 13. Typical VBAT Current vs. Temperature in RC Mode

Figure 14 shows the typical VBAT power state operating current vs. temperature in RC Autocalibration mode.

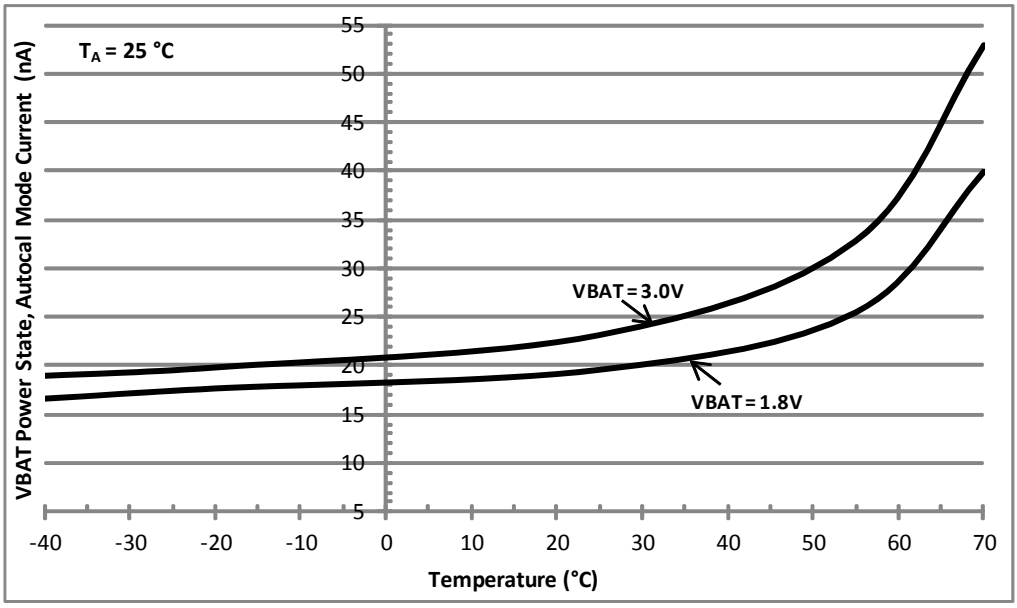


Figure 14. Typical VBAT Current vs. Temperature in RC Autocalibration Mode

Figure 15 shows the typical VBAT power state operating current vs. voltage for XT Oscillator and RC Oscillator modes and the average current in RC Autocalibrated mode, VCC = 0 V.

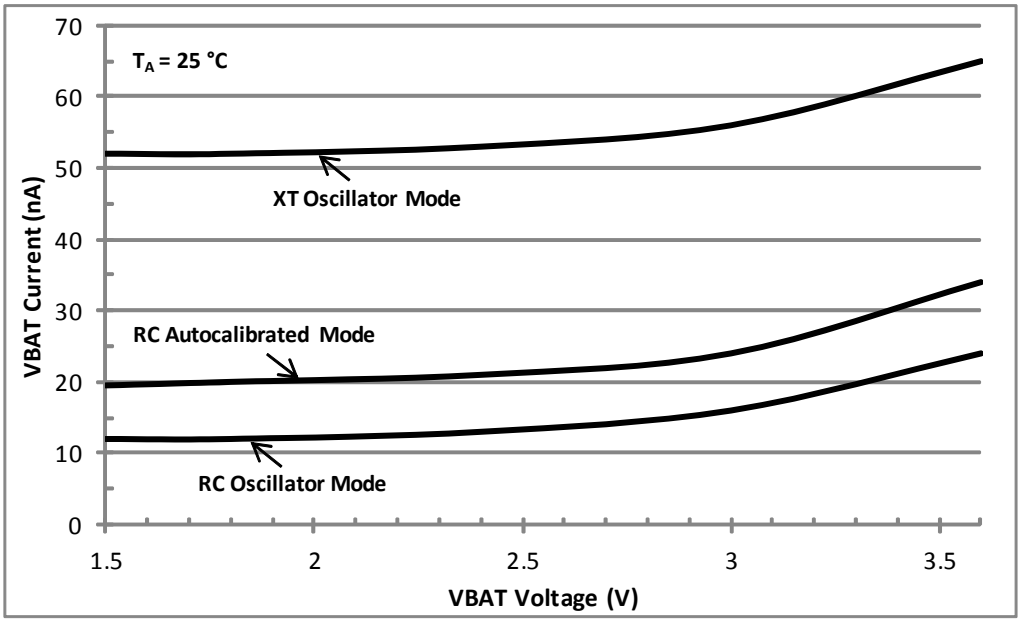


Figure 15. Typical VBAT Current vs. Voltage, Different Modes of Operation

Figure 16 shows the typical VBAT current when operating in the VCC power state, VCC = 1.7 V.

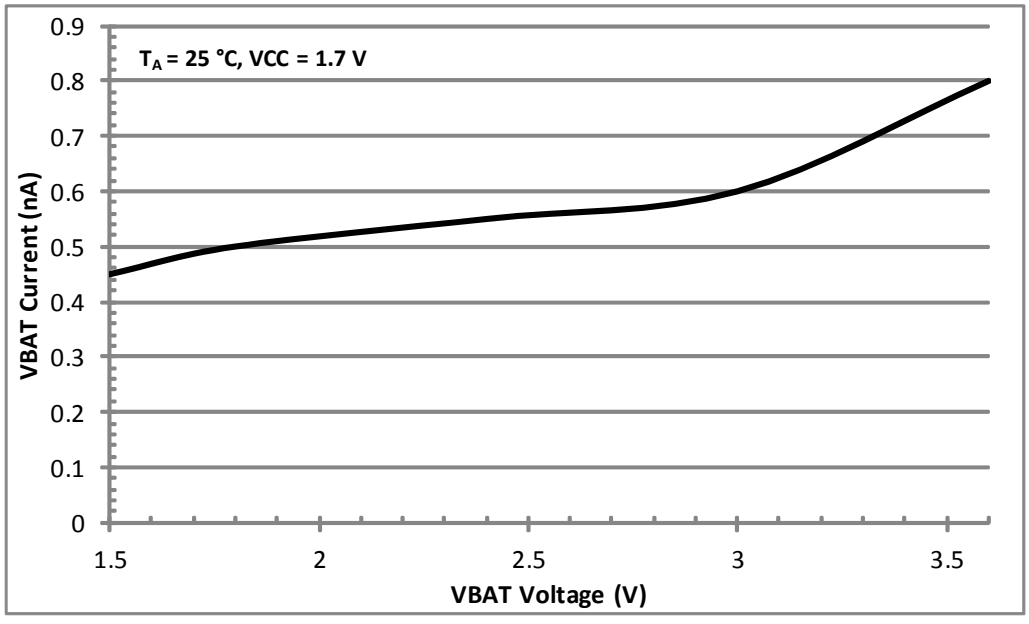


Figure 16. Typical VBAT Current vs. Voltage in VCC Power State

5.7 BREF Electrical Characteristics

Table 10 lists the parameters of the VBAT voltage thresholds. BREF values other than those listed in the table are not supported.

For Table 10, T_A = -20 °C to 70 °C, TYP values at 25 °C, VCC = 1.7 to 3.6V.

Table 10: BREF Parameters

SYMBOL	PARAMETER	BREF	MIN	TYP	MAX	UNIT
V_{BRF}	VBAT falling threshold	0111	2.3	2.5	3.3	V
		1011	1.9	2.1	2.8	
		1101	1.6	1.8	2.5	
		1111		1.4		
V_{BRR}	VBAT rising threshold	0111	2.6	3.0	3.4	V
		1011	2.1	2.5	2.9	
		1101	1.9	2.2	2.7	
		1111		1.6		
V_{BRH}	VBAT threshold hysteresis	0111		0.5		V
		1011		0.4		
		1101		0.4		
		1111		0.2		
T_{BR}	VBAT analog comparator recommended operating temperature range	All values	-20		70	°C

5.8 I^2C AC Electrical Characteristics

Figure 17 and Table 11 describe the I^2C AC electrical parameters.

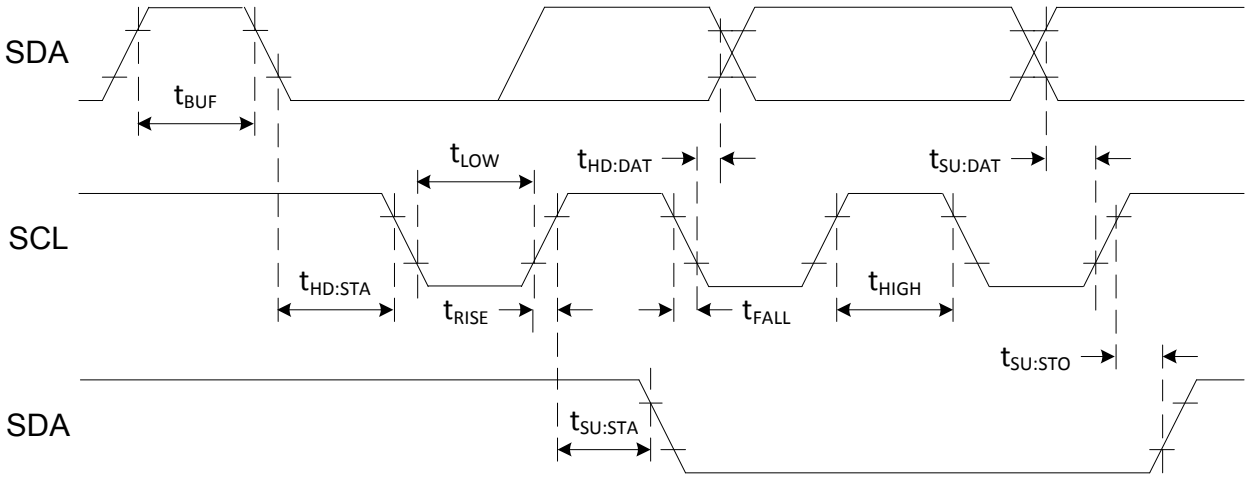


Figure 17. I²C AC Parameter Definitions

For Table 11, T_A = -40 °C to 85 °C, TYP values at 25 °C.

Table 11: I²C AC Electrical Parameters

SYMBOL	PARAMETER	VCC	MIN	TYP	MAX	UNIT
f_{SCL}	SCL input clock frequency	1.7V-3.6V	10		400	kHz
t_{LOW}	Low period of SCL clock	1.7V-3.6V	1.3			µs
t_{HIGH}	High period of SCL clock	1.7V-3.6V	600			ns
t_{RISE}	Rise time of SDA and SCL	1.7V-3.6V			300	ns
t_{FALL}	Fall time of SDA and SCL	1.7V-3.6V			300	ns
$t_{HD:STA}$	START condition hold time	1.7V-3.6V	600			ns
$t_{SU:STA}$	START condition setup time	1.7V-3.6V	600			ns
$t_{SU:DAT}$	SDA setup time	1.7V-3.6V	100			ns
$t_{HD:DAT}$	SDA hold time	1.7V-3.6V	0			ns
$t_{SU:STO}$	STOP condition setup time	1.7V-3.6V	600			ns
t_{BUF}	Bus free time before a new transmission	1.7V-3.6V	1.3			µs

5.9 SPI AC Electrical Characteristics

Figure 18, Figure 19, and Table 12 describe the SPI AC electrical parameters.

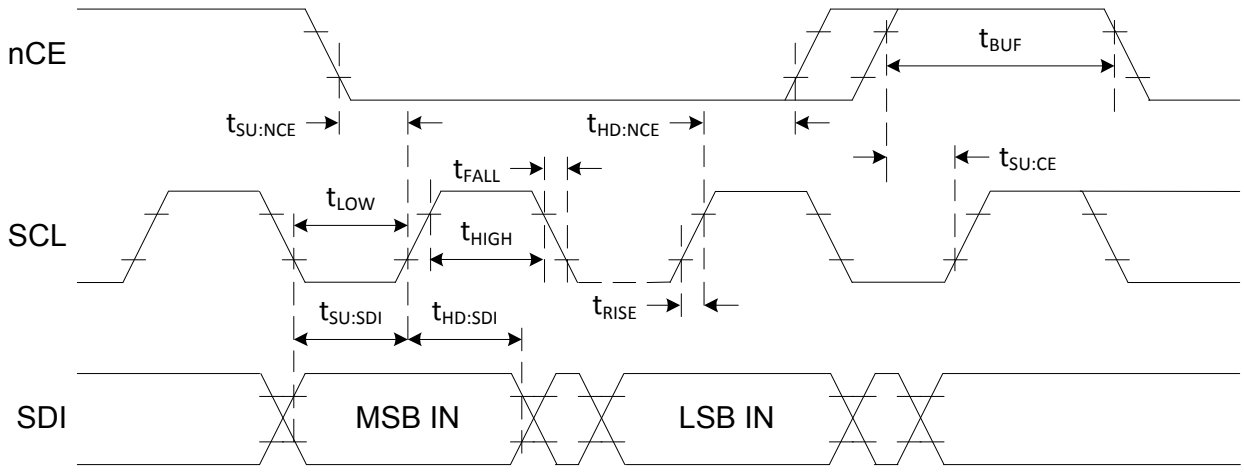


Figure 18. SPI AC Parameter Definitions – Input

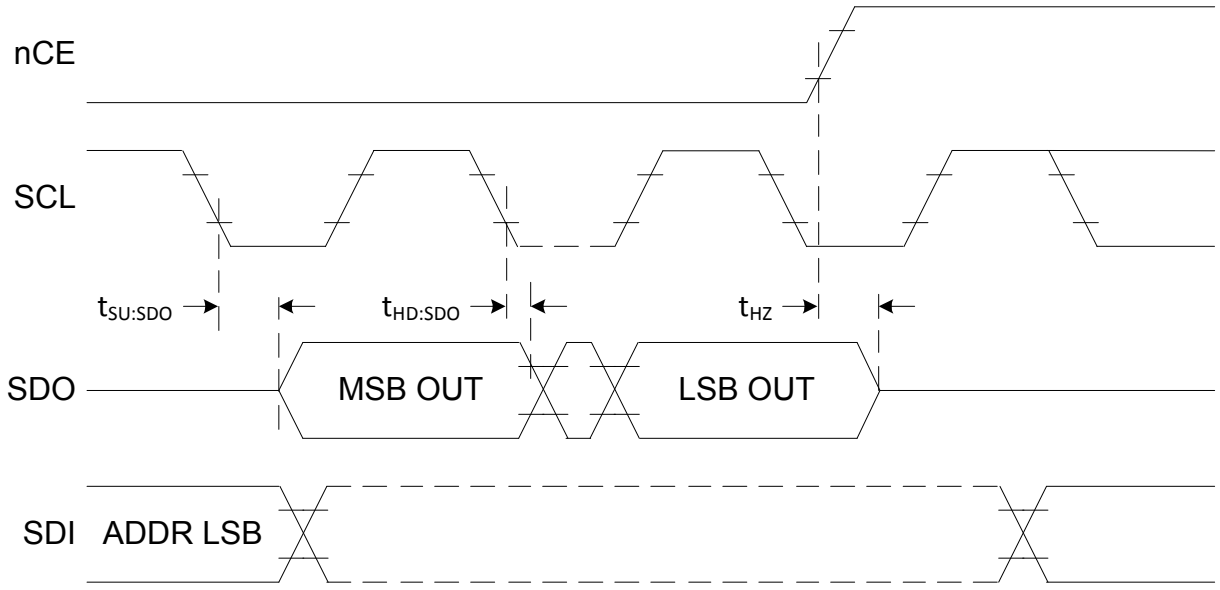


Figure 19. SPI AC Parameter Definitions – Output

For Table 12, T_A = -40 °C to 85 °C, TYP values at 25 °C.

Table 12: SPI AC Electrical Parameters

SYMBOL	PARAMETER	VCC	MIN	TYP	MAX	UNIT
f_{SCL}	SCL input clock frequency	1.7V–3.6V	0.01		2	MHz
t_{LOW}	Low period of SCL clock	1.7V–3.6V	200			ns
t_{HIGH}	High period of SCL clock	1.7V–3.6V	200			ns
t_{RISE}	Rise time of all signals	1.7V–3.6V			1	µs
t_{FALL}	Fall time of all signals	1.7V–3.6V			1	µs
$t_{SU:NCE}$	nCE low setup time to SCL	1.7V–3.6V	200			ns
$t_{HD:NCE}$	nCE hold time to SCL	1.7V–3.6V	200			ns
$t_{SU:CE}$	nCE high setup time to SCL	1.7V–3.6V	200			ns
$t_{SU:SDI}$	SDI setup time	1.7V–3.6V	40			ns
$t_{HD:SDI}$	SDI hold time	1.7V–3.6V	50			ns
$t_{SU:SDO}$	SDO output delay from SCL	1.7V–3.6V			150	ns
$t_{HD:SDO}$	SDO output hold from SCL	1.7V–3.6V	0			ns
t_{HZ}	SDO output Hi-Z from nCE	1.7V–3.6V			250	ns
t_{BUF}	nCE high time before a new transmission	1.7V–3.6V	200			ns

5.10 Power On AC Electrical Characteristics

Figure 20 and Table 13 describe the power on AC electrical characteristics for the FOUT pin and XT oscillator.

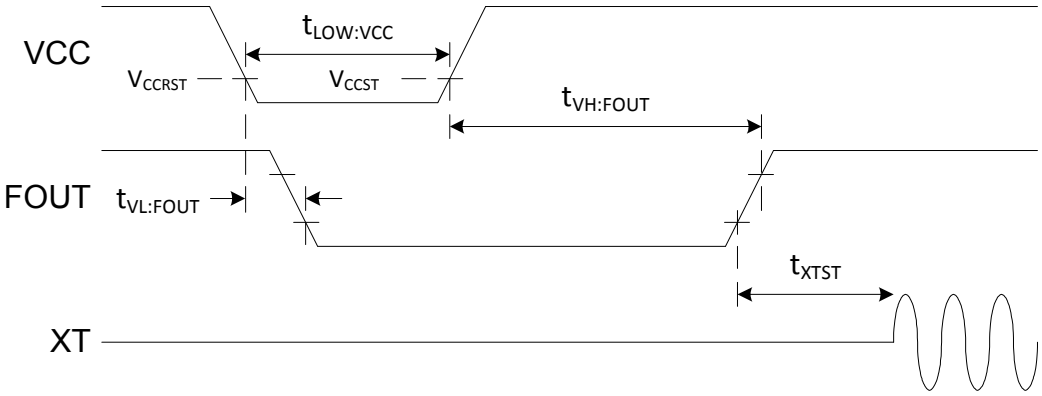


Figure 20. Power On AC Electrical Characteristics

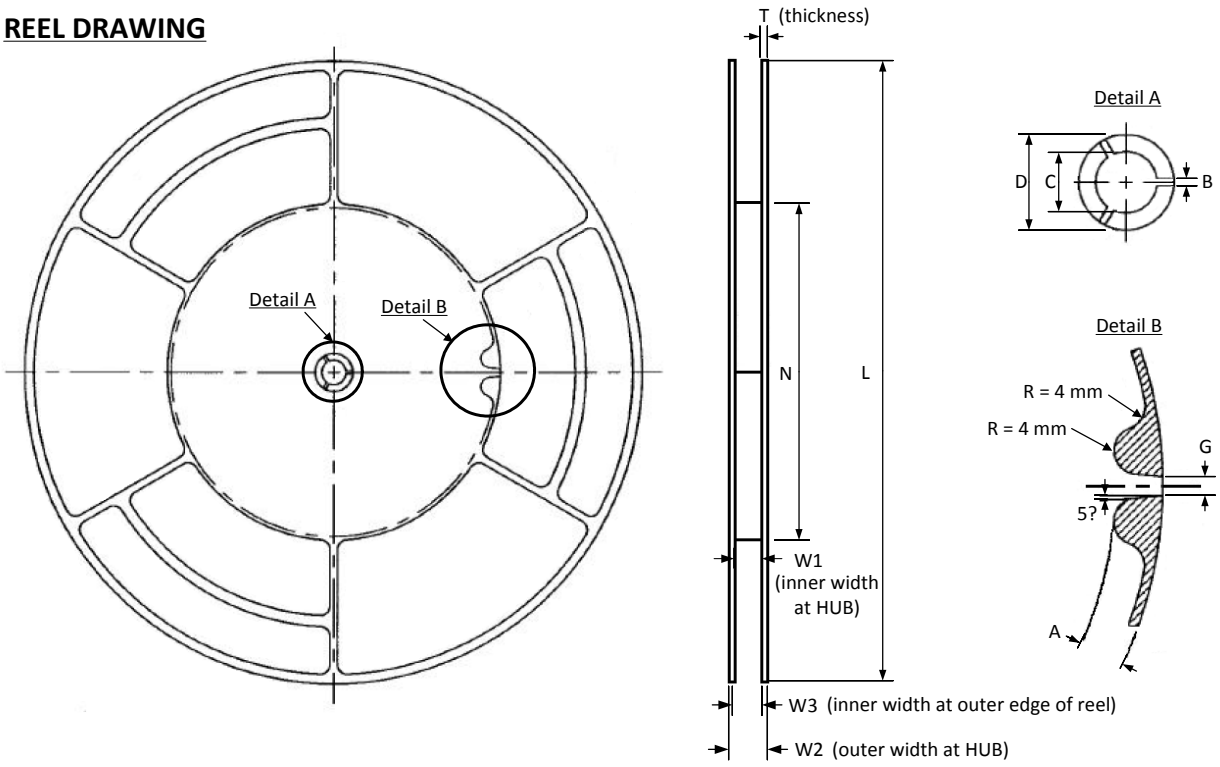
For Table 13, T_A = -40 °C to 85 °C, VBAT < 1.2 V

Table 13: Power On AC Electrical Parameters

SYMBOL	PARAMETER	VCC	T_A	MIN	TYP	MAX	UNIT
$t_{LOW:VCC}$	Low period of VCC to ensure a valid POR	1.7V–3.6V	85 °C		0.1		s
			25 °C		0.1		
			-20 °C		1.5		
			-40 °C		10		
$t_{VL:FOUT}$	VCC low to FOUT low	1.7V–3.6V	85 °C		0.1		s
			25 °C		0.1		
			-20 °C		1.5		
			-40 °C		10		
$t_{VH:FOUT}$	VCC high to FOUT high	1.7V–3.6V	85 °C		0.4		s
			25 °C		0.5		
			-20 °C		3		
			-40 °C		20		
t_{XTST}	FOUT high to XT oscillator start	1.7V–3.6V	85 °C		0.4		s
			25 °C		0.4		
			-20 °C		0.5		
			-40 °C		1.5		

6. Tape and Reel Information

REEL DRAWING



CARRIER TAPE DRAWING

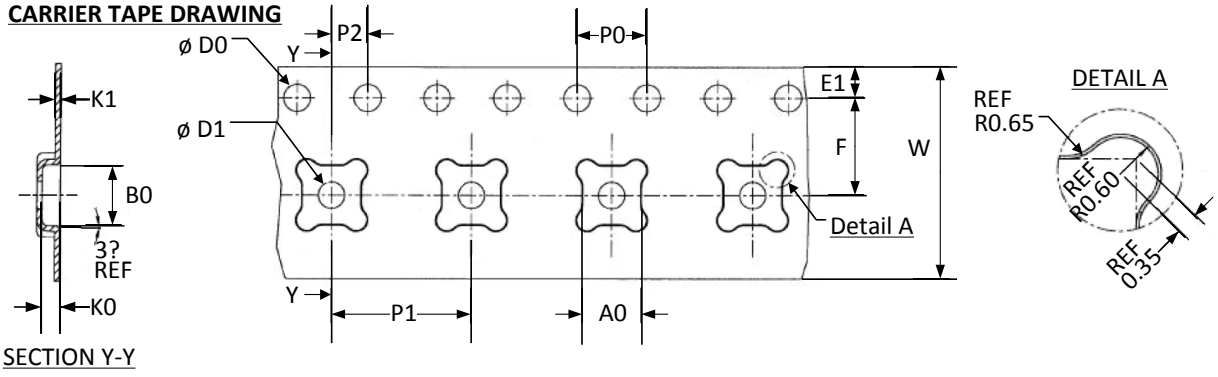


Table 14: Tape and Reel Dimensions

330 x 178 x 12 mm Reel Dimensions					3x3 QFN Carrier Tape Dimensions				
Symbol	**MIN**	**TYP**	**MAX**	**Units**	**Symbol**	**MIN**	**TYP**	**MAX**	**Units**
T	2.3	2.5	2.7	mm	B0	3.2	3.3	3.4	mm
N		178.0			K0	0.9	1.0	1.1	
L			330.0		K1	0.25	0.3	0.35	
W1	12.4	12.4	12.6		D0	1.50	1.55	1.60	
W2			18.4		D1	1.5			
W3	12.4		15.4		P0	3.9	4.0	4.1	
C	12.8	13.0	13.5		P1	7.9	8.0	8.1	
D	20.2				P2	1.9	2.0	2.1	
A		10.0			A0	3.2	3.3	3.4	
G		4.0			E1	1.65	1.75	1.85	
B	1.5				F	5.4	5.5	5.6	
					W	11.7	12.0	12.3	

7. Reflow Profile

Figure 22 illustrates the reflow soldering requirements.

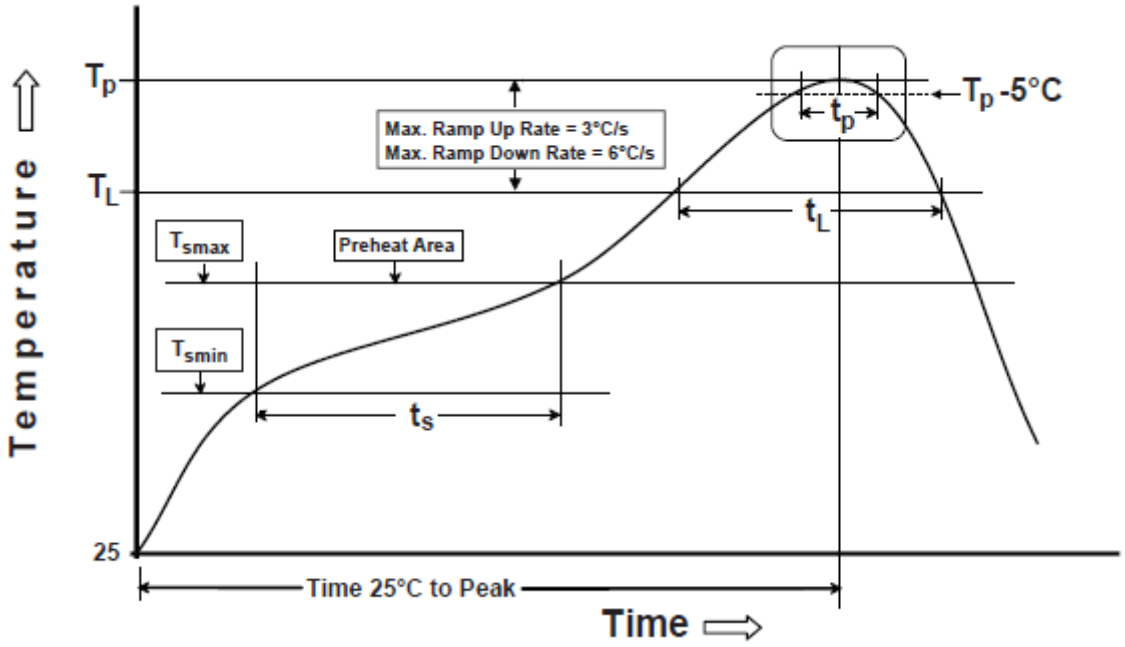


Figure 21. Reflow Soldering Diagram

Table 15: Reflow Soldering Requirements

Profile Feature	Requirement
Preheat/Soak Temperature Min (T_{smin}) Temperature Max (T_{smax}) Time (ts) from (T_{smin} to T_{smax})	150 °C 200 °C 60-120 seconds
Ramp-up rate (T_L to Tp)	3 °C/second max.
Liquidous temperature (T_L) Time (t_L) maintained above T_L	217 °C 60-150 seconds
Peak package body temperature (T_p)	260 °C max.
Time (t_p) within 5 °C of T_p	30 seconds max.
Ramp-down rate (T_p to T_L)	6 °C/second max.
Time 25 °C to peak temperature	8 minutes max.

8. Ordering Information

Table 16: Ordering Information

AB08XX Orderable Part Numbers		Package	Temperature Range	MSL Level[2]
P/N	Tape and Reel Qty			
AB0801-T3	3000pcs/reel	Pb-Free[1] 16-Pin QFN 3 x 3 mm	-40 to +85 °C	1
AB0803-T3	3000pcs/reel			
AB0804-T3	3000pcs/reel			
AB0805-T3	3000pcs/reel			
AB0811-T3	3000pcs/reel			
AB0813-T3	3000pcs/reel			
AB0814-T3	3000pcs/reel			
AB0815-T3	3000pcs/reel			

[1] Compliant and certified with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in raw homogeneous materials. The package was designed to be soldered at high temperatures (per reflow profile) and can be used in specified lead-free processes.

[2] Moisture Sensitivity Level rating according to the JEDEC J-STD-020D industry standard classifications.

9. Notes

i. The parts are manufactured in accordance with this specification. If other conditions and specifications which are required for this specification, please contact ABRACON for more information.

ii. ABRACON will supply the parts in accordance with this specification unless we receive a written request to modify prior to an order placement.

iii. In no case shall ABRACON be liable for any product failure from in appropriate handling or operation of the item beyond the scope of this specification.

iv. When changing your production process, please notify ABRACON immediately.

v. ABRACON Corporation's products are COTS – Commercial-Off-The-Shelf products; suitable for Commercial, Industrial and, where designated, Automotive Applications. ABRACON's products are not specifically designed for Military, Aviation, Aerospace, Life-dependant Medical applications or any application requiring high reliability where component failure could result in loss of life and/or property. For applications requiring high reliability and/or presenting an extreme operating environment, written consent and authorization from ABRACON Corporation is required. Please contact ABRACON Corporation for more information.

vi. All specifications and Marking will be subject to change without notice.

10. ABRACON CORPORATION – TERMS & CONDITIONS OF SALE

The following are the terms and conditions under which Abracon Corporation ("AB") agrees to sell, to the entity named on the face hereof ("Buyer"), the products specified on the face hereof (the "Products"). Notwithstanding Buyer's desire to use standardized RFQs, purchase order forms, order forms, acknowledgment forms and other documents which may contain terms in addition to or at variance with these terms, it is expressly understood and agreed that other forms shall neither add to, nor vary, these terms whether or not these terms are referenced therein. Buyer may assent to these terms by written acknowledgment, implication and/or by acceptance or payment of goods ordered any of which will constitute assent.

1. **Prices**: Prices shown on the face hereof are in US dollars, with delivery terms specified herein and are exclusive of any other charges including, without limitation, fees for export, special packaging, freight, insurance and similar charges. AB reserves the right to increase the price of Products by written notice to Buyer at least thirty (30) days prior to the original date of shipment. When quantity price discounts are quoted by AB, the discounts are computed separately for each type of product to be sold and are based upon the quantity of each type and each size ordered at any one time. If any discounted order is reduced by Buyer with AB's consent, the prices shall be adjusted to the higher prices, if applicable, for the remaining order.
2. **Taxes**: Unless otherwise specified in the quotation, the prices do not include any taxes, import or export duties, tariffs, customs charges or any such other levies. Buyer agrees to reimburse AB the amount of any federal, state, county, municipal, or other taxes, duties, tariffs, or custom charges AB is required to pay. If Buyer is exempt from any such charges, Buyer must provide AB with appropriate documentation.
3. **Payment Terms**: For each shipment, AB will invoice Buyer for the price of the Products plus all applicable taxes, packaging, transportation, insurance and other charges. Unless otherwise stated in a separate agreement or in AB's quotation, payments are due within thirty (30) days from the date of invoice, subject to AB's approval of Buyer's credit application. All invoicing disputes must be submitted in writing to AB within ten (10) days of the receipt of the invoice accompanied by a reasonably detailed explanation of the dispute. Payment of the undisputed amounts shall be made timely. AB reserves the right to require payment in advance or C.O.D. and otherwise modified credit terms. When partial shipments are made, payments for such shipments shall become due in accordance with the above terms upon submission of invoices. If, at the request of Buyer, shipment is postponed for more than thirty (30) days, payment will become due thirty days after notice to Buyer that Products are ready for shipment. Any unpaid due amounts will be subject to interest at one decimal five percent (1.5%) per month, or, if less, the maximum rate allowed by law.
4. **Delivery and Shipment**: Shipment dates are estimates only. Failure to deliver by a specified date shall neither entitle Buyer to any compensation nor impose any liability on AB. AB reserves the right to ship and bill ten percent more or less than the exact quantity specified on the face hereof. All shipments will be made Ex Works as per Incoterms 2000 from AB's place of shipment. In the absence of specific instructions, AB will select the carrier. Claims against AB for shortages must be made in writing within ten (10) days after the arrival of the shipment. AB is not required to notify Buyer of the shipment. Buyer shall pay all freight charges, insurance and other shipping expenses. Freight charges, insurance and other shipping expenses itemized in advance of actual shipment, if any, are estimates only that are calculated on the basis of standard tariffs and may not reflect actual costs. Buyer must pay actual costs.
5. **Purchase Order Changes and Cancellations**: Purchase orders for standard AB Products may not be canceled within sixty (60) days of the original shipping date. Purchase orders for non-standard AB Products are non-cancelable and non-returnable. All schedule changes must be requested at least thirty (30) days prior to original shipping date. Maximum schedule change "push-out" shall be no more than thirty (30) days from original shipping date. AB may terminate or cancel this order, in whole or in part, at any time prior to the completion of performance by written notice to Buyer without incur-

ring any liability to Buyer for breach of contract or otherwise. AB reserves the right to allocate Products in its sole discretion among Buyer and other potential buyers, or defer or delay the shipment of any Product, which is in short supply due to any reason.

6. **Title and Risk of Loss**: AB's responsibility for any loss or damage ends, and title passes, when Products are delivered Ex Works as per Incoterms 2000 at AB's designated shipping location to carrier, to Buyer or to Buyer's agent, whichever occurs first.
7. **Packing**: Packaging shall be AB's standard shipping materials or as specified on the face hereof. Any cost of non-standard packaging and handling requested by Buyer shall be abided by AB provided Buyer gives reasonable prior notice and agrees in writing to pay additional costs.
8. **Security Interest**: Buyer hereby grants AB a purchase money security interest in the Products sold and in the proceeds of resale of such Products until such time as Buyer has paid all charges. AB retains all right and remedies available to AB under the Uniform Commercial Code.
9. **Specifications**: Specifications for each Product are the specifications specified in the published datasheets of such Product, as of the date of AB's quotation (the "Specifications"). Except as otherwise agreed, AB reserves the right to modify the Specifications at any time without adversely affecting the functionality.
10. **Acceptance**: Unless Buyer notifies AB in writing within ten (10) days from the date of receipt of Products that the Products fail to conform to the Specifications, the Products will be deemed accepted by Buyer. No such claim of non-conformity shall be valid if (i) the Products have been altered, modified or damaged by Buyer, (ii) the rejection notice fails to explain the non-conformance in reasonable detail and is not accompanied by a test report evidencing the non-conformity, or (iii) rejected Products are not returned to AB within thirty (30) days of rejection; provided, that no Product returns may be made without a return material authorization issued by AB.
11. **Limited Warranties and Disclaimers**: AB warrants to Buyer that each Product, for a period of twelve (12) months from shipment date thereof, will conform to the Specifications and be free from defects in materials and workmanship. AB's sole liability and Buyer's exclusive remedy for Products that fail to conform to this limited warranty ("Defective Products") is limited to repair or replacement of such Defective Products, or issue a credit or rebate of no more than the purchase price of such Defective Products, at AB's sole option and election. This warranty shall not apply: (i) if Products have been damaged or submitted to abnormal conditions (mechanical, electrical, or thermal) during transit, storage, installation, or use; or (ii) if Products are subject to Improper Use (as defined below); or (iii) if the non-conformance of Products results from misuse, neglect, improper testing, storage, installation, unauthorized repair, alteration, or excess usage at or beyond the maximum values (temperature limit, maximum voltage, and other Specification limits) defined by AB; (iv) to any other default not attributable to AB; or (v) removal, alteration, or tampering of the original AB product labeling. This warranty does not extend to Products or components purchased from entities other than AB or AB's authorized distributors or to third-party software or documentation that may be supplied with any Product. In the event no defect or breach of warranty is discovered by AB upon receipt of any returned Product, such Product will be returned to Buyer at Buyer's expense and Buyer will reimburse AB for the transportation charges, labor, and associated charges incurred in testing the allegedly Defective Product. The above warranty is for Buyer's benefit only, and is non-transferable. OTHER THAN THE LIMITED WARRANTY SET FORTH ABOVE, AB MAKES NO WARRANTIES, EXPRESS, STATUTORY, IMPLIED, OR OTHERWISE AND SPECIFICALLY DISCLAIMS THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE AND NON-INFRINGEMENT, TO THE MAXIMUM EXTENT PERMITTED BY LAW. WITHOUT LIMITING THE GENERALITY OF THE FOREGOING DISCLAIMERS, AB INCORPORATES BY REFERENCE ANY PRODUCT-SPECIFIC WARRANTY DISCLAIMERS SET FORTH IN THE PUBLISHED PRODUCT DATASHEETS.
12. **Limitation of Liability**: AB SHALL HAVE NO LIABILITY FOR LOSS ARISING FROM ANY CLAIM MADE AGAINST BUYER, OR FOR SPECIAL, INDIRECT, RELIANCE, INCIDENTAL, CONSEQUENTIAL, OR PUNITIVE DAMAGES INCLUDING, WITHOUT LIMITATION, LOSS OF USE, PROFITS, REVENUES, OR COST OF PROCUREMENT OF SUBSTITUTE GOODS BASED ON ANY BREACH

OR DEFAULT OF AB, HOWEVER CAUSED, AND UNDER ANY THEORY OF LIABILITY. BUYER'S SOLE REMEDY AND AB'S SOLE AND TOTAL LIABILITY FOR ANY CAUSE OF ACTION, WHETHER IN CONTRACT (INCLUDING BREACH OF WARRANTY) OR TORT (INCLUDING NEGLIGENCE OR MISREPRESENTATION) OR UNDER STATUTE OR OTHERWISE SHALL BE LIMITED TO AND SHALL NOT EXCEED THE AGGREGATE AMOUNTS PAID BY BUYER TO AB FOR PRODUCTS WHICH GIVE RISE TO CLAIMS. BUYER SHALL ALWAYS INFORM AB OF ANY BREACH AND AFFORD AB REASONABLE OPPORTUNITY TO CORRECT ANY BREACH. THE FOREGOING LIMITATIONS SHALL APPLY REGARDLESS OF WHETHER AB HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES AND NOTWITHSTANDING THE FAILURE OF ESSENTIAL PURPOSE OF ANY LIMITED REMEDY.

13. **Improper Use**: Buyer agrees and covenants that, without AB's prior written approval, Products will not be used in life support systems, human implantation, nuclear facilities or systems or any other application where Product failure could lead to loss of life or catastrophic property damage (each such use being an "Improper Use"). Buyer will indemnify and hold AB harmless from any loss, cost, or damage resulting from Improper Use of the Products.
14. **Miscellaneous**: In the event of any insolvency or inability to pay debts as they become due by Buyer, or voluntary or involuntary bankruptcy proceeding by or against Buyer, or appointment of a receiver or assignee for the benefit of creditors of Buyer, AB may elect to cancel any unfulfilled obligations. No Products or underlying information or technology may be exported or re-exported, directly or indirectly, contrary to US law or US Government export controls. AB will be excused from any obligation to the extent performance thereof is caused by, or arises in connection with, acts of God, fire, flood, riots, material shortages, strikes, governmental acts, disasters, earthquakes, inability to obtain labor or materials through its regular sources, delay in delivery by AB's supplies or any other reason beyond the reasonable control of AB. In the event any one or more of the provisions contained herein shall for any reason be held to be invalid, illegal, or unenforceable in any respect, such invalidity, illegality, or unenforceability shall not affect any other provision hereof and these terms shall be construed as if such invalid, illegal, or unenforceable provision had never been contained herein. A waiver of a breach or default under these terms shall not be a waiver of any subsequent default. Failure of AB to enforce compliance with any of these terms shall not constitute a waiver of such terms. These terms are governed by the laws of the State of California without reference to conflict of law principles. The federal and state courts located within the State of California will have exclusive jurisdiction to adjudicate any dispute arising out of these terms.